506831735 08/23/2021

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SENG KIM YE	04/28/2014
HONG WAN NG	04/28/2014

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.
Street Address:	8000 S. FEDERAL WAY, P.O. BOX 6
City:	BOISE
State/Country:	IDAHO
Postal Code:	83707-0006

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17409427

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	010829-9113.US04
NAME OF SUBMITTER:	CHRISTINE DUNN
SIGNATURE:	/Christine Dunn/
DATE SIGNED:	08/23/2021

Total Attachments: 4

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> **PATENT** REEL: 057260 FRAME: 0752

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ASSIGNMENT BY INVENTORS

This Assignment is by the following individuals (the "Assignors"):

- Seng Kim Ye, having a mailing address of Block 311C, #05-32 Anchorvale Lane, Singapore 543311, Republic of Singapore; and
- Hong Wan Ng, having a mailing address of Block 75C, #24-76 Redhill Road, Singapore 153075, Republic of Singapore.

The Assignors inve	nted one or more certain invent	tions (the "invention(s)") o	lescribed in
an application for Letters I	Patent of the United States titled	STACKED SEMICOND	UCTOR DIE
ASSEMBLIES WITH SUP	PORT MEMBERS AND ASSO	CIATED SYSTEMS AND	METHODS
naming the Assignors as i	nventors, and filed on		as U.S.
Application No	(the "Application").	The Assignors authorize	the
Assignee, identified below	, or its representatives to insert	the application number a	ind filing
date of the Application wh	en known.		

Micron Technology, Inc., a corporation of Delaware having its principal place of business at 8000 S. Federal Way, P.O. Box 6, Boise, Idaho 83707-0006 ("Assignee"), desires to acquire the entire right, title and interest in and to the Invention(s) and the Application, and in and to any patents (collectively, "Patents") that may be granted for the invention(s) in the United States or in any foreign countries.

For valuable consideration, the receipt and sufficiency of which Assignors acknowledge, Assignors hereby sell, assign, and transfer to Assignee, its successors, legal representatives and assigns, the entire right, title and interest in and to: the invention(s), the Application, and any Patents; any divisions, continuations, and continuations-in-part of the Application and any other application claiming priority rights from the Application; any reissues, reexaminations, or extensions of any and all Patents; the right to file foreign applications directly in the name of Assignee; and the right to claim priority rights deriving from the Application (collectively, the "Rights"). Assignors warrant that Assignors own the Rights, and that the Rights are unencumbered. Assignors also agree to not sign any writing or do any act conflicting with this assignment, and, without further compensation, sign all documents and do

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Attorney Docket No. 10829-9113.US00 Micron Docket No. 2013-0568.00/US

such additional acts as Assignee deems necessary or desirable to: perfect Assignee's enjoyment of the Rights; conduct proceedings regarding the Rights, including any litigation or interference proceedings; or perfect or defend title to the Rights. This Assignment may be executed in counterparts.

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Attorney Docket No. 10829-9113:US00 Micron Docket No. 2013-0568.00/US

Date: 04/28/3014	4.7
Date:	Seng Kim Ye
Notice and the Control of the North Control of the	
Mitness to Signature by Seng Kim Ye:	
signature Ong Yeon Chon	
Printed Name	
Dull	
Signature Tan Li Shan Shided	

州人

Printed Name

Attorney Dacket No. 10829-9113.US00 Micron Docket No. 2013-0568.00/US

Date:	
Date:	Hong Wan Ng
Mitness to Cionalure by Hone Mon Nev	
Witness to Signature by Hong Wan Ng:	
<u></u>	
Signature Ong Yeow Chon	
Printed Name	
Signature Tan Li Shan Shirley Printed Name	

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PATENT REEL: 057260 FRAME: 0756